

00 00

00 000 000,

00 00

00 00 : BEST-507 250G 00 0000

00 : 000 / 000 / 000 / 00 00 SMD IC 0 BGA IC 00, 0 00 000000 00 00 00 00...0

SOLDER PASTE

low temperature



500g

Low residue / Rapid welding / Solder spot bright

Product Usage

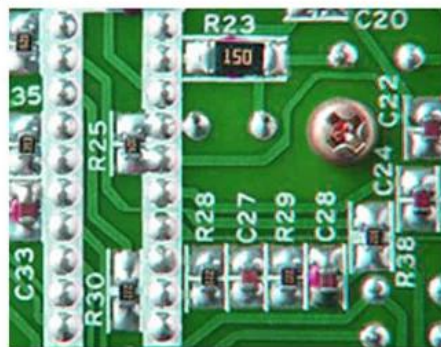
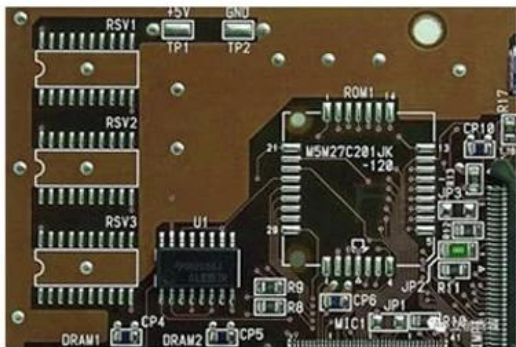


MODEL	BST-508
SHELF LIFE	6 months
INGREDIENT	Sn63/Pb37
WEIGHT	500g
MELTING POINT	183°C

Having a large insulation resistance does not corrode the PCB, and the requirements for no-cleaning can be achieved.



High impedance, full and bright solder, low residue



Welding requirements for a wide range of products



UNIFORM SOLDER JOINT
LOW TEMPERATURE MELTING POINT



PRODUCT SIZE



63.0MM



75MM

52MM

